

AO6405

30V P-Channel MOSFET

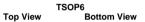
General Description

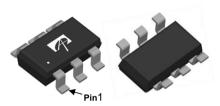
The AO6405 uses advanced trench technology to provide excellent $R_{\mathrm{DS(ON)}}$ with low gate charge. This device is suitable for use as a load switch or in PWM applications.

Product Summary

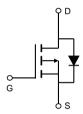
 $\begin{array}{lll} V_{DS} & -30V \\ I_{D} \; (at \; V_{GS} \! = \! 10V) & -5A \\ R_{DS(ON)} \; (at \; V_{GS} \! = \! 10V) & < 52m\Omega \\ R_{DS(ON)} \; (at \; V_{GS} \! = \! 4.5V) & < 87m\Omega \end{array}$











Absolute Maximum Ratings T_A=25°C unless otherwise noted

/								
Parameter		Symbol	Maximum	Units				
Drain-Source Voltage		V _{DS}	-30	V				
Gate-Source Voltage		V_{GS}	±20	V				
Continuous Drain	T _A =25°C		-5					
Current	T _A =70°C	'D	-4.2	Α				
Pulsed Drain Current ^C		I _{DM}	-20					
	T _A =25°C	D	2	W				
Power Dissipation ^B	T _A =70°C	$-P_{D}$	1.3	VV				
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C				

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s Steady-State R _{θJA}		47.5	62.5	°C/W			
Maximum Junction-to-Ambient AD			74	110	°C/W			
Maximum Junction-to-Lead	Steady-State	$R_{\theta JL}$	37	50	°C/W			



Electrical Characteristics (T_{.1}=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units			
STATIC PARAMETERS									
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-30			V			
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-30V, V _{GS} =0V			-1	μА			
	Zero Gate Voltage Brain Guirent	$T_{J}=$:55°C		-5	μΑ			
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±20V			±100	nA			
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=-250\mu A$	-1.4	-1.9	-2.4	V			
I _{D(ON)}	On state drain current	V_{GS} =-10V, V_{DS} =-5V	-20			Α			
R _{DS(ON)} Si	Static Drain-Source On-Resistance	V _{GS} =-10V, I _D =-5A		34	52	mΩ			
		T _J =1	25°C	52	70	1112.2			
		V_{GS} =-4.5V, I_D =-4A		54	87	mΩ			
g _{FS}	Forward Transconductance	V_{DS} =-5V, I_{D} =-5A		10		S			
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V		-0.7	-1	V			
Is	Maximum Body-Diode Continuous Curr			-2.5	Α				
DYNAMIC	PARAMETERS								
C _{iss}	Input Capacitance			520		pF			
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =-15V, f=1MHz	Z	100		pF			
C _{rss}	Reverse Transfer Capacitance			65		pF			
R_g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz	3.5	7.5	11.5	Ω			
SWITCHI	NG PARAMETERS								
Q _g (10V)	Total Gate Charge			9.2	11	nC			
Q _g (4.5V)	Total Gate Charge	V _{GS} =-10V, V _{DS} =-15V, I _D =-5.	^	4.6	6	nC			
Q_{gs}	Gate Source Charge	- v _{GS} =-10v, v _{DS} =-15v, 1 _D =-5	^	1.6		nC			
Q_{gd}	Gate Drain Charge			2.2		nC			
t _{D(on)}	Turn-On DelayTime			7.5		ns			
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-15V, R_L =3	Ω,	5.5		ns			
t _{D(off)}	Turn-Off DelayTime	$R_{GEN}=3\Omega$		19		ns			
t _f	Turn-Off Fall Time			7		ns			
t _{rr}	Body Diode Reverse Recovery Time	I _F =-5A, dI/dt=100A/μs		11		ns			
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =-5A, dI/dt=100A/μs		5.3		nC			

A. The value of R_{BJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The value in any given application depends on the user's specific board design.

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B. The power dissipation P_D is based on $T_{J(MAX)}$ =150° C, using \leq 10s junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150° C. Ratings are based on low frequency and duty cycles to keep initialT₁=25° C.

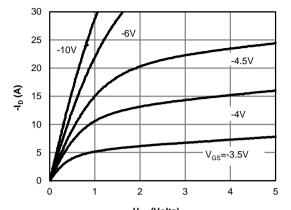
D. The R_{NJA} is the sum of the thermal impedence from junction to lead R_{NJL} and lead to ambient. E. The static characteristics in Figures 1 to 6 are obtained using <300 μ s pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedence which is measured with the device mounted on 1in² FR-4 board with

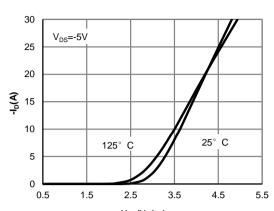
²oz. Copper, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.



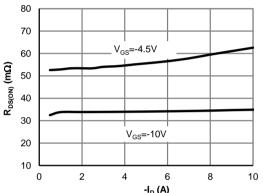
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



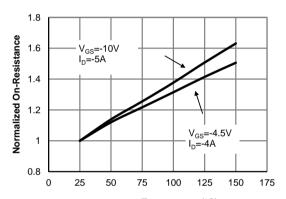
-V_{DS} (Volts) Fig 1: On-Region Characteristics (Note E)



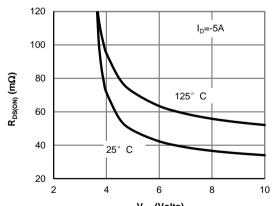
-V_{GS}(Volts) Figure 2: Transfer Characteristics (Note E)



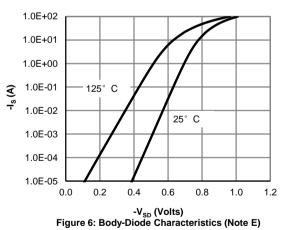
-I_D (A) Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)



Temperature (°C)
Figure 4: On-Resistance vs. Junction Temperature
(Note E)

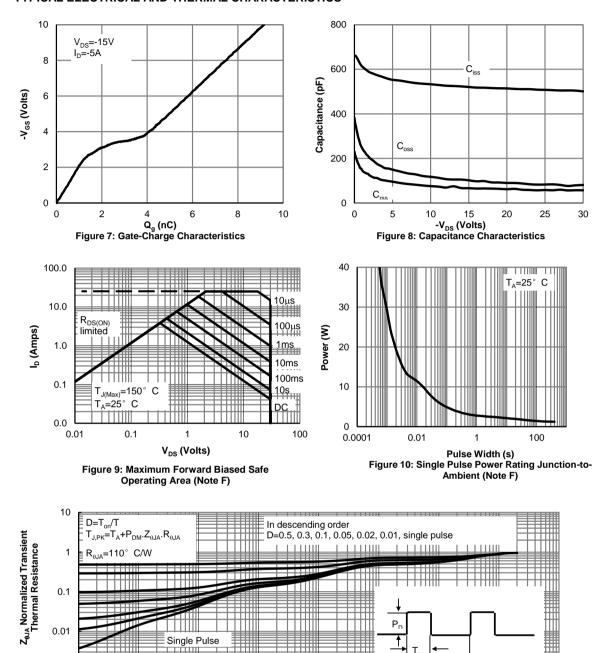


-V_{GS} (Volts)
Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)





TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



Pulse Width (s)
Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

0.1

10

100

1000

0.01

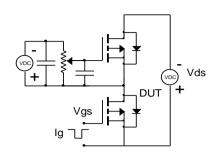
0.001 - 0.00001

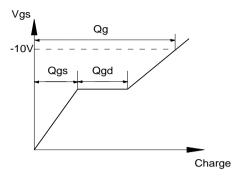
0.0001

0.001

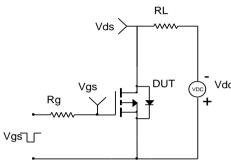


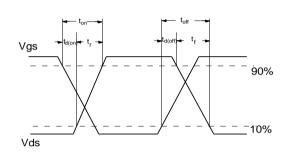
Gate Charge Test Circuit & Waveform





Resistive Switching Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

